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REV	DATE	BY	DESCRIPTION	DATE	BY	APP
AD 25			SEE SHEET 1	-	-	-

- △ HOUSING MATERIAL: THERMOPLASTIC, COLOR-NATURAL.
- △ CONTACT MATERIAL: COPPER ALLOY.
- △ CONTACT FINISH: .00127-.00254 [.000050-.000100] NICKEL UNDERPLATE ALL OVER; .00076 [.000030] GOLD PLATE IN CONTACT AREA, TIN-LEAD PLATED SOLDER TAILS.
- △ SOLDER TAILS MUST FIT HOLE PATTERN AS SHOWN ON THE RECOMMENDED P.C. BOARD LAYOUT.
- △ PART NUMBER IS OBSOLETE.

113.66 [4.475]	101.60 [4.000]	-40-	101.60 [4.000]	-40-	216.51 [8.524]	227.33 [8.950]	234.95 [9.250]	246-	533514-9
									533514-8
									533514-7
149.22 [5.875]	137.16 [5.400]	54	137.16 [5.400]	54	287.63 [11.324]	298.45 [11.750]	306.07 [12.050]	330	533514-6
141.60 [5.575]	129.54 [5.100]	-54-	129.54 [5.100]	-54-	272.39 [10.724]	283.21 [11.150]	290.83 [11.450]	312	533514-5
133.98 [5.275]	121.92 [4.800]	-48-	121.92 [4.800]	-48-	257.15 [10.124]	267.97 [10.550]	275.59 [10.850]	294	533514-4
126.36 [4.975]	114.30 [4.500]	45	114.30 [4.500]	45	241.91 [9.524]	252.73 [9.950]	260.35 [10.250]	276	533514-3
									533514-2
111.12 [4.375]	99.06 [3.900]	39	99.06 [3.900]	39	211.43 [8.324]	222.25 [8.750]	229.87 [9.050]	240	533514-1
K	G	F	E	D	C	B	A	POSN	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT. **REVISED** **DATE** **BY**
 DATE: 08/07/08 BY: SKR/MT
 TTI ELECTRONICS CORPORATION
 HARRISBURG, PA 17105-3608

INCHES (DIMENSIONS) **UNLESS OTHERWISE SPECIFIED**
 DIMENSIONS: .0005" (MIN) .001" (MAX)
 TOLERANCES: .0005" (MIN) .001" (MAX)
 SURFACE FINISH: .0005" (MIN) .001" (MAX)
 MATERIAL: THERMOPLASTIC, COPPER ALLOY

PROJECT: HDI, 3 ROW, RECEPTACLE ASSEMBLY.
 1 GUIDE PIN, 3 MOUNTING HOLES, 3.005(.100)
 LONG SOLDER TAILS, 0.00076(.000030) GOLD PLATE
 SIZE: SEE DRAWING NO. A100779(G)=533514
 CUSTOMER DRAWING

DATE: 4.1 SHEET: 2 OF 2